505710610 10/07/2019

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
CHI-WEN CHANG	09/18/2019
JUI-FENG KUAN	09/18/2019

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.		
Street Address:	NO. 8, LI-HSIN RD. VI, HSINCHU SCIENCE PARK		
City:	HSINCHU		
State/Country:	TAIWAN		
Postal Code:	300		

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	16566570	

CORRESPONDENCE DATA

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NAME OF SUBMITTER: RANDY A. NORANBROCK		
SIGNATURE: /Randy A. Noranbrock/		
DATE SIGNED:	10/07/2019	

Total Attachments: 1

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PATENT 505710610 REEL: 050642 FRAME: 0669

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- 1) Chi-Wen CHANG
- 2) Jui-Feng KUAN

RECORDED: 10/07/2019

who has made a certain new and useful invention, hereby sells, assigns and transfers unto <u>TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.</u>, having a place of business at No. 8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu 300, Taiwan R.O.C.

300, Taiwan R.O.C. its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

INT	INTEGRATED CIRCUIT DESIGN METHOD, SYSTEM AND COMPUTER PROGRAM						
PRO	PRODUCT						
(a)	for which an application for United States Letters Patent United States Patent Application No16/566,570	was filed on	2019-09-10 ; or	, and identified by			
(b)	for which an application for United States Letters Patent was executed on						
all Ur contin	the undersigned hereby authorizes and requests the United States Letters Patent which may be granted therefore putations-in-part thereof, and the right to all benefits underty to the said ASSIGNEE, for its interest as ASSIGNEE, s that the attorneys of record in said application shall hereaft	and any and all r the Internation its successors, a	extensions, divisions, i mal Convention for the ssigns and legal represe	reissues, continuations, or e Protection of Industrial			
ASSI applic ASSI	AND the undersigned hereby agrees to transfer a li- cation for and obtaining original, divisional, reissued or exter GNEE, its successors, assigns and legal representatives, and cations for patent based thereon, growing out of or related GNEE, its successors, assigns and legal representatives, decoration hereby transferred.	nded Letters Pa I without furthe I to the said in	tent of the United States r remuneration, in and to vention; and to execut	s, upon request of the said to any improvements, and te any papers by the said			
SIGN	ED on the date indicated aside my signature:						
Ď	the West Changer	>	319/9/1A				
Nan	ne: Chi-Wen CHANG	Date:	•••••	······			
2)	Jui-Yeng Vivan no: Jui-Feng KUAN		2019/9/18)			
Nan	ne: Jui-Feng KUAN	Date:					

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PATENT REEL: 050642 FRAME: 0670